TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HC107AP,TC74HC107AF,TC74HC107AFN

Dual J-K Flip Flop with Clear

The TC74HC107A is a high speed CMOS DUAL J-K FLIP FLOP fabricated with silicon gate C^2MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

In accordance with the logic levels applied to the J and K inputs, the outputs change state on the negative going transition of the clock pulse.

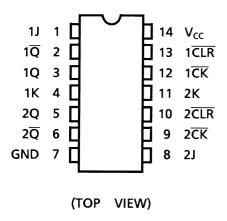
 \overline{CLR} is independent of the clock and is accomplished by a low logic level on the input.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

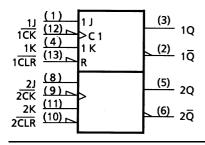
Features

- High speed: $f_{max} = 75 \text{ MHz}$ (typ.) at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 2 \mu A \text{ (max)}$ at $T_{a} = 25 \text{°C}$
- High noise immunity: V_{NIH} = V_{NIL} = 28% V_{CC} (min)
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: | IOH | = IOL = 4 mA (min)
- Balanced propagation delays: $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range: VCC (opr) = 2~6 V
- Pin and function compatible with 74LS107

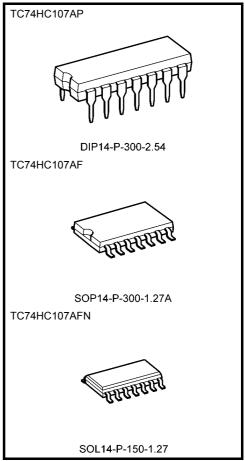
Pin Assignment



IEC Logic Symbol



Note: xxxFN (JEDEC SOP) is not available in Japan.



Weight

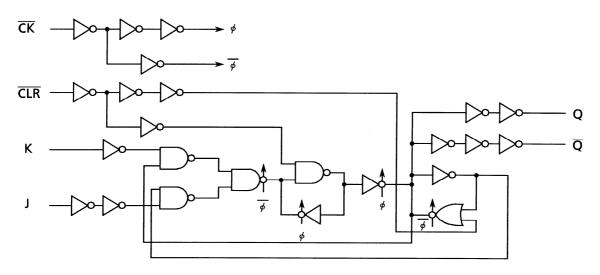
DIP14-P-300-2.54 : 0.96 g (typ.) SOP14-P-300-1.27A : 0.18 g (typ.) SOL14-P-150-1.27 : 0.12 g (typ.)

Truth Table

	Inp	uts		Out	puts	Function
CLR	J	K	CK	Q	Q	FullClion
L	Х	Х	Х	L	Н	Clear
Н	L	L	\rightarrow	Qn	\overline{Q}_n	No Change
Н	L	Н	\rightarrow	L	Н	
Н	Н	L		Н	L	
Н	Н	Н		\overline{Q}_n	Qn	Toggle
Н	Х	Х		Qn	$\overline{\overline{Q}}_n$	No Change

X: Don't care

System Diagram



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	-0.5~7	V
DC input voltage	V _{IN}	-0.5~V _{CC} + 0.5	V
DC output voltage	V _{OUT}	-0.5~V _{CC} + 0.5	V
Input diode current	l _{IK}	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V _{CC} /ground current	Icc	±50	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T _{stg}	-65~150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of $Ta = -40^{\circ}C \sim 65^{\circ}C$. From $Ta = 65^{\circ}C$ to $85^{\circ}C$ a derating factor of -10 mW/°C shall be applied until 300 mW.



Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	2~6	V
Input voltage	V _{IN}	0~V _{CC}	V
Output voltage	V _{OUT}	0~V _{CC}	V
Operating temperature	T _{opr}	-40~85	°C
		0~1000 (V _{CC} = 2.0 V)	
Input rise and fall time	t _r , t _f	0~500 (V _{CC} = 4.5 V)	ns
		0~400 (V _{CC} = 6.0 V)	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

Electrical Characteristics

DC Characteristics

		Test Condition		Ta = 25°C			Ta = -40~85°C			
Characteristics	Symbol				Min	Тур.	Max	Min	Max	Unit
				2.0	1.50	_	_	1.50	_	
High-level input voltage	V_{IH}		_		3.15	_	_	3.15	_	V
, and the second				6.0	4.20	_	_	4.20	_	
				2.0	_	_	0.50	_	0.50	
Low-level input voltage	V _{IL}		_		_	_	1.35		1.35	V
				6.0	_	_	1.80		1.80	
	V _{ОН}	V _{IN} = V _{IH} or V _{IL}		2.0	1.9	2.0	_	1.9	_	
			$I_{OH} = -20 \mu A$	4.5	4.4	4.5	_	4.4	_	
High-level output voltage				6.0	5.9	6.0	_	5.9	_	V
			$I_{OH} = -4 \text{ mA}$	4.5	4.18	4.31	_	4.13	_	
			I _{OH} = -5.2 mA	6.0	5.68	5.80	_	5.63	_	
		V _{IN} = V _{IH} or		2.0	_	0.0	0.1	_	0.1	
			$I_{OL} = 20 \mu A$	4.5	_	0.0	0.1	_	0.1	
Low-level output voltage	V_{OL}			6.0	_	0.0	0.1	_	0.1	V
		V _{IL}	I _{OL} = 4 mA	4.5		0.17	0.26	_	0.33	
			I _{OL} = 5.2 mA	6.0	_	0.18	0.26	_	0.33	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		6.0	_	_	±0.1	_	±1.0	μА
Quiescent supply current	Icc	$V_{IN} = V_{C}$	V _{IN} = V _{CC} or GND		_	_	2.0	_	20.0	μΑ

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Timing Requirements (input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition	Test Condition			Ta = -40 ~85°C	Unit
			V _{CC} (V)	Тур.	Limit	Limit	<u> </u>
Minimum pulse width			2.0	_	75	95	
(CK)	t _{W (L)}	_	4.5	_	15	19	ns
(CK)	t _{W (H)}		6.0	_	13	16	
Minimum nulao width			2.0	_	75	95	
Minimum pulse width (CLR)	t _{W (L)}	_	4.5	_	15	19	ns
(CLR)			6.0	_	13	16	
			2.0	_	75	95	
Minimum set-up time	t _s	_	4.5	_	15	19	ns
			6.0	_	13	16	
			2.0	_	0	0	
Minimum hold time	t _h	_	4.5	_	0	0	ns
			6.0	_	0	0	
Minimum removal time			2.0	_	25	30	
(CLR)	t _{rem}	_	4.5	_	5	6	ns
(CLR)			6.0	_	5	5	
			2.0	_	6	5	
Clock frequency	f	_	4.5	_	31	25	MHz
			6.0	_	37	30	

AC Characteristics ($C_L = 15 \text{ pF}$, $V_{CC} = 5 \text{ V}$, $Ta = 25^{\circ}\text{C}$, input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Output transition time	t _{TLH} t _{THL}	_	_	4	8	ns
Propagation delay time $(\overline{CK} - Q, \overline{Q})$	t _{pLH}	_	_	11	21	ns
Propagation delay time $(\overline{\text{CLR}} - Q, \overline{Q})$	t _{pLH}	_	_	12	24	ns
Maximum clock frequency	f _{max}		34	75	_	MHz



AC Characteristics ($C_L = 50$ pF, input: $t_r = t_f = 6$ ns)

		Test Condition		Ta = 25°C		Ta = -4	l lmit		
Characteristics	Symbol		V _{CC} (V)	Min	Тур.	Max	Min	Max	Unit
	4 —		2.0	_	30	75	_	95	
Output transition time	t _{TLH}	_	4.5	_	8	15	_	19	ns
	t _{THL}		6.0	_	7	13	_	16	
Propagation delay	4		2.0	_	48	125	_	155	
time	t _{pLH} t _{pHL}	_	4.5	_	14	25	_	31	ns
$(\overline{CK}-Q,\ \overline{Q})$			6.0	_	12	21	_	26	
Propagation delay	t _{pLH} t _{pHL}		2.0	_	52	140	_	175	
time		_	4.5	_	15	28	_	35	ns
$(\overline{CLR}-Q,\ \overline{Q})$			6.0	_	13	24	_	30	
	f _{max}		2.0	6	23	_	5	_	
Maximum clock frequency		_	4.5	31	70	_	25	_	MHz
in equality			6.0	37	80	_	30	_	
Input capacitance	C _{IN}	_		_	5	10	_	10	pF
Power dissipation	C _{PD}				33				nE.
capacitance	(Note)				33				pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

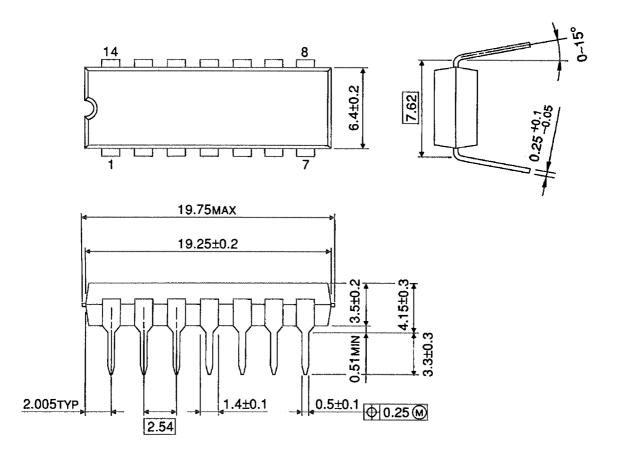
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Average operating current can be obtained by the equation:

$$I_{CC}$$
 (opr) = $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2$ (per F/F)

Package Dimensions

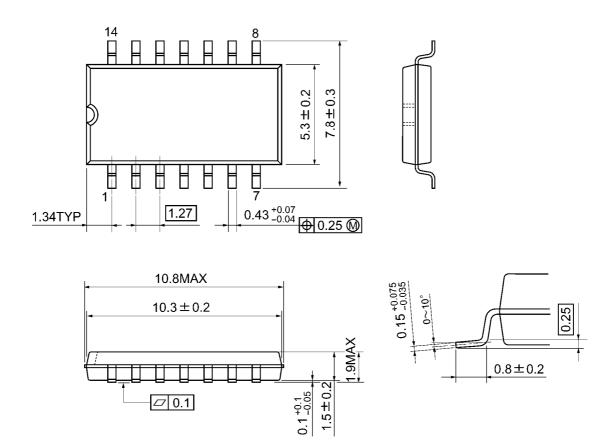
DIP14-P-300-2.54 Unit: mm



Weight: 0.96 g (typ.)

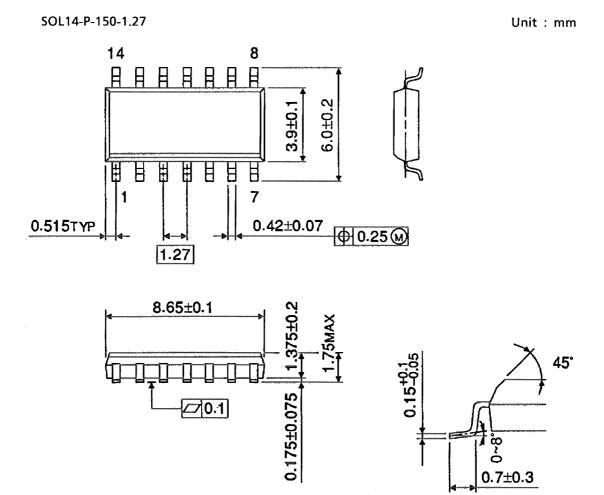
Package Dimensions

SOP14-P-300-1.27A Unit: mm



Weight: 0.18 g (typ.)

Package Dimensions (Note)



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Note: This package is not available in Japan.

Weight: 0.12 g (typ.)

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